



# **Zener Voltage Regulators**

500 mW SOD-123 Surface Mount

# MMSZxxxT1G Series, SZMMSZxxxT1G Series

Three complete series of Zener diodes are offered in the convenient, surface mount plastic SOD-123 package. These devices provide a convenient alternative to the leadless 34-package style.

#### **Features**

- 500 mW Rating on FR-4 or FR-5 Board
- Wide Zener Reverse Voltage Range 2.4 V to 56 V
- Package Designed for Optimal Automated Board Assembly
- Small Package Size for High Density Applications
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- AEC-Q101 Qualified and PPAP Capable
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- Pb-Free Packages are Available\*

#### **Mechanical Characteristics**

CASE: Void-free, transfer-molded, thermosetting plastic case

FINISH: Corrosion resistant finish, easily Solderable

## MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

**POLARITY:** Cathode indicated by polarity band

FLAMMABILITY RATING:  $UL\ 94\ V-0$ 

#### **MAXIMUM RATINGS**

Rating	Symbol	Max	Unit
Total Power Dissipation on FR–5 Board, (Note 1) @ T <sub>L</sub> = 75°C Derated above 75°C	P <sub>D</sub>	500 6.7	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	340	°C/W
Thermal Resistance, Junction-to-Lead (Note 2)	$R_{ heta JL}$	150	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. FR-5 = 3.5 X 1.5 inches.
- Thermal Resistance measurement obtained via infrared Scan Method.



SOD-123 CASE 425 STYLE 1



#### MARKING DIAGRAM



xx = Device Code
M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MMSZxxxT1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
SZMMSZxxxT1G	SOD-123 (Pb-Free)	3,000 / Tape & Reel
MMSZxxxT3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel
SZMMSZxxxT3G	SOD-123 (Pb-Free)	10,000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **DEVICE MARKING INFORMATION**

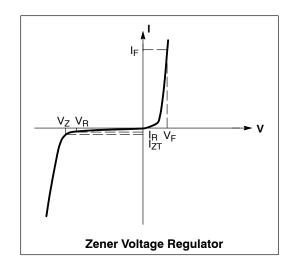
See specific marking information in the device marking column of the Electrical Characteristics table on page 2 of this data sheet.

1

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.95$ V Max. @ $I_F = 10$ mA)

	. ,
Symbol	Parameter
VZ	Reverse Zener Voltage @ I <sub>ZT</sub>
I <sub>ZT</sub>	Reverse Current
Z <sub>ZT</sub>	Maximum Zener Impedance @ I <sub>ZT</sub>
I <sub>R</sub>	Reverse Leakage Current @ V <sub>R</sub>
V <sub>R</sub>	Reverse Voltage
I <sub>F</sub>	Forward Current
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>



# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted, $V_F = 0.9 \text{ V Max.}$ @ $I_F = 10 \text{ mA}$ )

			V <sub>Z1</sub> (Volts) otes 3 and		Z <sub>ZT1</sub> (Note 5)	V <sub>Z2</sub> (Vo (Notes 3		<b>Z<sub>ZT2</sub></b> (Note 5)		everse Current
	Device		@ I <sub>ZT1</sub>	= 5 mA		@ I <sub>ZT2</sub> = 1 mA		I <sub>R</sub> @ V <sub>R</sub>		
Device*	Marking	Min	Nom	Max	Ω	Min	Max	Ω	μΑ	Volts
MMSZ2V4T1G	T1	2.28	2.4	2.52	100	1.7	2.1	600	50	1
MMSZ2V7T1G	T2	2.57	2.7	2.84	100	1.9	2.4	600	20	1
MMSZ3V0T1G	Т3	2.85	3.0	3.15	95	2.1	2.7	600	10	1
MMSZ3V3T1G	T4	3.14	3.3	3.47	95	2.3	2.9	600	5	1
MMSZ3V6T1G	T5	3.42	3.6	3.78	90	2.7	3.3	600	5	1
MMSZ3V9T1G	U1	3.71	3.9	4.10	90	2.9	3.5	600	3	1
MMSZ4V3T1G	U2	4.09	4.3	4.52	90	3.3	4.0	600	3	1
MMSZ4V7T1G	U3	4.47	4.7	4.94	80	3.7	4.7	500	3	2
MMSZ5V1T1G	U4	4.85	5.1	5.36	60	4.2	5.3	480	2	2
MMSZ5V6T1G/T3G	U5	5.32	5.6	5.88	40	4.8	6.0	400	1	2
MMSZ6V2T1G	V1	5.89	6.2	6.51	10	5.6	6.6	150	3	4
MMSZ6V8T1G	V2	6.46	6.8	7.14	15	6.3	7.2	80	2	4
MMSZ7V5T1G	V3	7.13	7.5	7.88	15	6.9	7.9	80	1	5
MMSZ8V2T1G	V4	7.79	8.2	8.61	15	7.6	8.7	80	0.7	5
MMSZ9V1T1G	V5	8.65	9.1	9.56	15	8.4	9.6	100	0.5	6
MMSZ10T1G/T3G	A1	9.50	10	10.50	20	9.3	10.6	150	0.2	7
MMSZ11T1G	A2	10.45	11	11.55	20	10.2	11.6	150	0.1	8
MMSZ12T1G	А3	11.40	12	12.60	25	11.2	12.7	150	0.1	8
MMSZ13T1G	A4	12.35	13	13.65	30	12.3	14.0	170	0.1	8
MMSZ15T1G	A5	14.25	15	15.75	30	13.7	15.5	200	0.05	10.5
MMSZ16T1G	X1	15.20	16	16.80	40	15.2	17.0	200	0.05	11.2
MMSZ18T1G/T3G	X2	17.10	18	18.90	45	16.7	19.0	225	0.05	12.6
MMSZ20T1G	Х3	19.00	20	21.00	55	18.7	21.1	225	0.05	14
MMSZ22T1G	X4	20.90	22	23.10	55	20.7	23.2	250	0.05	15.4
MMSZ24T1G	X5	22.80	24	25.20	70	22.7	25.5	250	0.05	16.8



<sup>3.</sup> The type numbers shown have a standard tolerance of  $\pm 5\%$  on the nominal Zener Voltage.

4. Tolerance and Voltage Designation: Zener Voltage ( $V_Z$ ) is measured with the Zener Current applied for PW = 1 ms.

Z<sub>ZT</sub> and Z<sub>ZK</sub> are measured by dividing the AC voltage drop across the device by the AC current applied.
The specified limits are for I<sub>Z(AC)</sub> = 0.1 I<sub>Z(DC)</sub>, with the AC frequency = 1 kHz.
 \*Include SZ-prefix devices where applicable.

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$  unless otherwise noted,  $V_F = 0.9 \text{ V Max.}$  @  $I_F = 10 \text{ mA}$ )

			V <sub>Z1</sub> (Volts) otes 6 and		Z <sub>ZT1</sub> (Note 8)	V <sub>Z2</sub> (Vo (Notes 6 a	,	Z <sub>ZT2</sub> (Note 8)		everse Current
	Device		@ I <sub>ZT1</sub>	= 2 mA		@ I <sub>ZT2</sub> = 0	).1 mA	@ I <sub>ZT2</sub> = 0.5 mA	I <sub>R</sub> @	V <sub>R</sub>
Device*	Marking	Min	Nom	Max	Ω	Min	Max	Ω	μΑ	Volts
MMSZ27T1G/T3G	Y1	25.65	27	28.35	80	25	28.9	300	0.05	18.9
MMSZ30T1G	Y2	28.50	30	31.50	80	27.8	32	300	0.05	21
MMSZ33T1G	Y3	31.35	33	34.65	80	30.8	35	325	0.05	23.1
MMSZ36T1G	Y4	34.20	36	37.80	90	33.8	38	350	0.05	25.2
MMSZ39T1G	Y5	37.05	39	40.95	130	36.7	41	350	0.05	27.3
MMSZ43T1G	Z1	40.85	43	45.15	150	39.7	46	375	0.05	30.1
MMSZ47T1G	Z2	44.65	47	49.35	170	43.7	50	375	0.05	32.9
MMSZ51T1G	Z3	48.45	51	53.55	180	47.6	54	400	0.05	35.7
MMSZ56T1G/T3G	Z4	53.20	56	58.80	200	51.5	60	425	0.05	39.2

<sup>6.</sup> The type numbers shown have a standard tolerance of  $\pm 5\%$  on the nominal Zener Voltage.

Tolerance and Voltage Designation: Zener Voltage (V<sub>Z</sub>) is measured with the Zener Current applied for PW = 1 ms.
 Z<sub>ZT</sub> and Z<sub>ZK</sub> are measured by dividing the AC voltage drop across the device by the AC current applied.
 The specified limits are for I<sub>Z(AC)</sub> = 0.1 I<sub>Z(DC)</sub>, with the AC frequency = 1 kHz.

 \*Include SZ-prefix devices where applicable.

#### TYPICAL CHARACTERISTICS

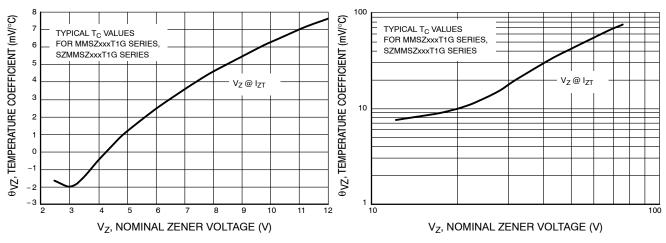


Figure 1. Temperature Coefficients (Temperature Range –55°C to +150°C)

Figure 2. Temperature Coefficients (Temperature Range – 55°C to +150°C)

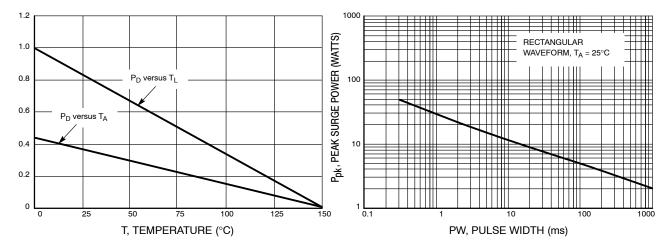


Figure 3. Steady State Power Derating

Figure 4. Maximum Nonrepetitive Surge Power

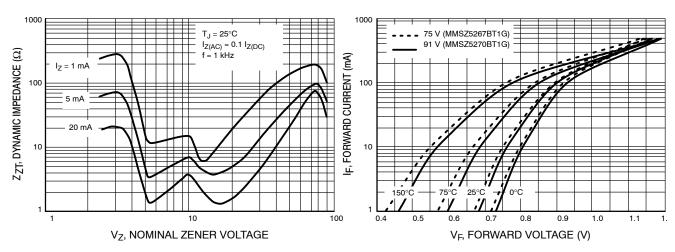


Figure 5. Effect of Zener Voltage on Zener Impedance

Figure 6. Typical Forward Voltage



# **TYPICAL CHARACTERISTICS**

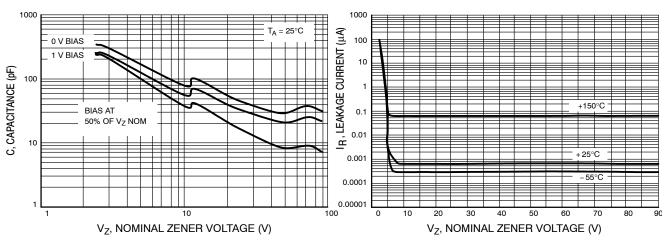


Figure 7. Typical Capacitance

Figure 8. Typical Leakage Current

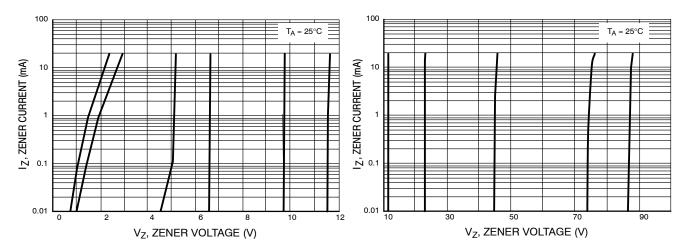


Figure 9. Zener Voltage versus Zener Current (V<sub>Z</sub> Up to 12 V)

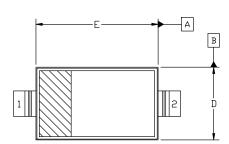
Figure 10. Zener Voltage versus Zener Current (12 V to 91 V)



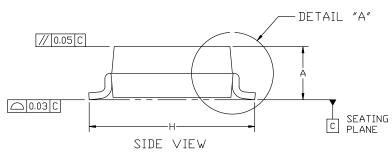


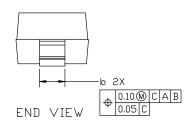
# SOD-123 2-LEAD, 1.60x2.69x1.16 **CASE 425 ISSUE H**

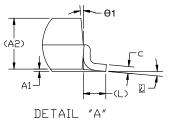
**DATE 29 FEB 2024** 



TOP VIEW



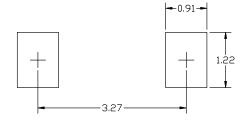




## NOTES:

- DIMENSION AND TOLERANCING PER ASME Y14.5M, 2018
- 2. CONTROLLING DIMENSION: MILLIMETERS

	MILLIMETER				
DIM	MIN.	N□M.	MAX.		
А	0.94	1.17	1.35		
A1	0.00	0.05	0.10		
A2	1.16 REF.				
b	0.51	0.61	0.71		
C	_	_	0.15		
D	1.40	1.60	1.80		
E	2.54	2.69	2.84		
Н	3.56	3.68	3,86		
L	0.25 REF.				
<u>S</u>	0°		10°		
θ1	0°		10°		



RECOMMENDED MOUNTING FOOTPRINT \*For additional information on or Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference manual SDLDERRM/D.

# **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98ASB42927B	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOD-123 2-LEAD, 1.60x2.69x1.16		PAGE 1 OF 1	

onsemi and ONSEMI. are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, Onsemi, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. Onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase

#### ADDITIONAL INFORMATION

**TECHNICAL PUBLICATIONS:** 

 $\textbf{Technical Library:} \ \underline{www.onsemi.com/design/resources/technical-documentation}$ 

onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at

www.onsemi.com/support/sales